personalization of the booklet and which is connected flatly to the flexible layer.

11. Booklet according to claim 9, characterized in that the data page (37) has a flexible layer which is connected to the data carrier on both outer sides of the latter.

12. Booklet according to claim 11, characterized in that the flexible layer is folded and has a fold (39) in which a sewing-in point is formed.

13. Booklet according to one of claims 9 to 12, characterized in that the data carrier has an addressable electronic component, in particular a chip.

14. Booklet according to claim 13, characterized in that the electronic component is integrated into the data carrier and, in particular, is laminated in.

15. A method for producing a booklet substantially as hereinbefore described with reference to the accompanying drawings.

personalization of the booklet and which is connected flatly to the flexible layer.

11. Booklet according to claim 9, characterized in that the data page (37) has a flexible layer which is connected to the data carrier on both outer sides of the latter.

12. Booklet according to claim 11, characterized in that the flexible layer is folded and has a fold (39) in which a sewing-in point is formed.

13. Booklet according to one of claims 9 to 12, characterized in that the data carrier has an addressable electronic component, in particular a chip.

14. Booklet according to claim 13, characterized in that the electronic component is integrated into the data carrier and, in particular, is laminated in.